### PATENT ASSIGNMENT

## Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE: NEW ASSIGNMENT

NATURE OF CONVEYANCE: ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
Young-Hoo Kim	07/05/2012
Sang Won Bae	07/05/2012
Kuntack Lee	07/05/2012
Hyosan Lee	07/10/2012

## RECEIVING PARTY DATA

Name:	amsung Electronics Co., Ltd.			
Street Address:	29, Samsung-ro, Yeongtong-gu, Suwon-si			
City:	Gyeonggi-do			
State/Country:	KOREA, REPUBLIC OF			

#### PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13616254

### **CORRESPONDENCE DATA**

**Fax Number**: 9198541401 **Phone**: 919-854-1400

Email: msalazar@myersbigel.com

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

via US Mail.

Correspondent Name: MBSS / Marthenn Salazar

Address Line 1: 4140 Parklake Ave

Address Line 2: Suite 600

Address Line 4: Raleigh, NORTH CAROLINA 27612

ATTORNEY DOCKET NUMBER:	5649-3487
NAME OF SUBMITTER:	Marthenn Salazar

Total Attachments: 5

PATENT REEL: 028964 FRAME: 0307 :H \$40.00

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PATENT REEL: 028964 FRAME: 0308

#### ASSIGNMENT

THIS ASSIGNMENT, made by us, Young-Hoo Kim, citizen of the Republic of Korea, residing at 202-1202, Hyundai Hometown 2 cha Apt., Hogye 3-dong, Dongan-gu, Anyang-si, Gyeonggi-do, Republic of Korea, Sang Won Bae, citizen of the Republic of Korea, residing at 1114-1104, 11Block, 2Danji, Humansia Apt. Seochang-dong, Namdonggu, Incheon, Republic of Korea, Kuntack Lee, citizen of the Republic of Korea, residing at 101-402, Ggumegreen Hyowon Apt., 1116-3, Ingye-dong, Paldal-gu, Suwon-si, Gyeonggi-do, Republic of Korea and Hyosan Lee, citizen of the Republic of Korea, residing at 110-1703, World Meridian Apt., Uman 2-dong, Paldal-gu, Suwon-si, Gyeonggi-do, Republic of Korea;

WHEREAS, we are the joint inventors of certain new and useful improvements in METHODS OF MANUFACTURING A THREE-DIMENSIONAL SEMICONDUCTOR DEVICE for which an application for United States Letters Patent has been filed, or is being filed concurrently, in the United States Patent and Trademark Office. We hereby authorize and request Myers Bigel Sibley & Sajovec, P.A., to insert here in parentheses (Application No. 13/6/16, 254, filed Syttmbus 14, 2012) the filing W. M. M. W. date and application number of said application when known or to file this Assignment concurrently with the application, and

WHEREAS, Samsung Electronics Co., Ltd., a Korean corporation having a principal place of business at 129, Samsung-ro, Yeongtong-gu, Suwon-si, Gyeonggi-do, 443-742, Republic of Korea, hereinafter referred to as assignee, is desirous of acquiring the entire right, title and interest in and to said invention as described in said application, and in and to any and all Letters Patent which shall be granted therefor in the United States of America and all foreign countries;

NOW, THEREFORE, To Whom It May Concern, be it known that for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, we have sold and by these presents do hereby sell, assign, transfer and convey unto the said assignee, its successors and assigns, the entire right, title and interest in and to the said invention and application, and in and to any and all continuations, continuations-in-part, or divisions thereof, and in and to any and all Letters Patent of the United States of America and all foreign countries or reissues thereof which may be granted therefor or thereon, for the full end of the term for which said Letters Patent may be granted, together with the right to claim the priority of said application in all foreign countries in accordance with the International Convention, the same to be held and enjoyed by said assignee, its successors and assigns, as

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#### ASSIGNMENT – CONTINUED

fully and entirely as the same would have been held and enjoyed by us if this assignment and sale had not been made.

We hereby request that said Letters Patent be issued in accordance with this assignment.

We further covenant and agree that, at the time of the execution and delivery of these presents, we possess full title to the invention and application above-mentioned, and that we have the unencumbered right and authority to make this assignment.

We further covenant and agree to bind our heirs, legal representatives and assigns, promptly to communicate to said assignee or its representatives any facts known to us relating to said invention, to testify in any interference or legal proceedings involving said invention, to execute any additional papers which may be requested to confirm the right of the assignee, its representatives, successors or assigns to secure patent or similar protection for the said invention in all countries and to vest in the assignee complete title to the said invention and Letters Patent, without further compensation, but at the expense of said assignee, its successors, assigns and other legal representatives.

			•			
IN WITNE	SS WHEREO	F, I have hereu	into set my	hand and sea	l on this 🚣	/ day
of July	, 2012.					
	Yo	K7m You ung-Hoo Kim	uy Hoo	_(SEAL)		
Witnessed by:						
Date:		_				

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# ASSIGNMENT - CONTINUED

IN WI	TNESS WHEREOF, I have hereunto set my hand and seal on this
of July	, 2012.
,	Bre Sang Won (SEAL) Sang Won Bae
Witnessed by:	
Date:	

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# ASSIGNMENT - CONTINUED

	IN WITNE	SS WHERE	OF, I have hereun	to set my h	and and seal o	n this <u>5+4</u>	day
of	July	, 2012.					
			Cuntack Lee	وو	(SEAL)		
Witne	ssed by:						
Date:							

## ASSIGNMENT - CONTINUED

IN WITNES	SS WHEREOF, I have hereunto set my hand and seal on this 10th day				
	Hyo son Hyosa	Lee n Lee	(SEAL)		
Witnessed by:					
Date					

PATENT REEL: 028964 FRAME: 0313

RECORDED: 09/14/2012